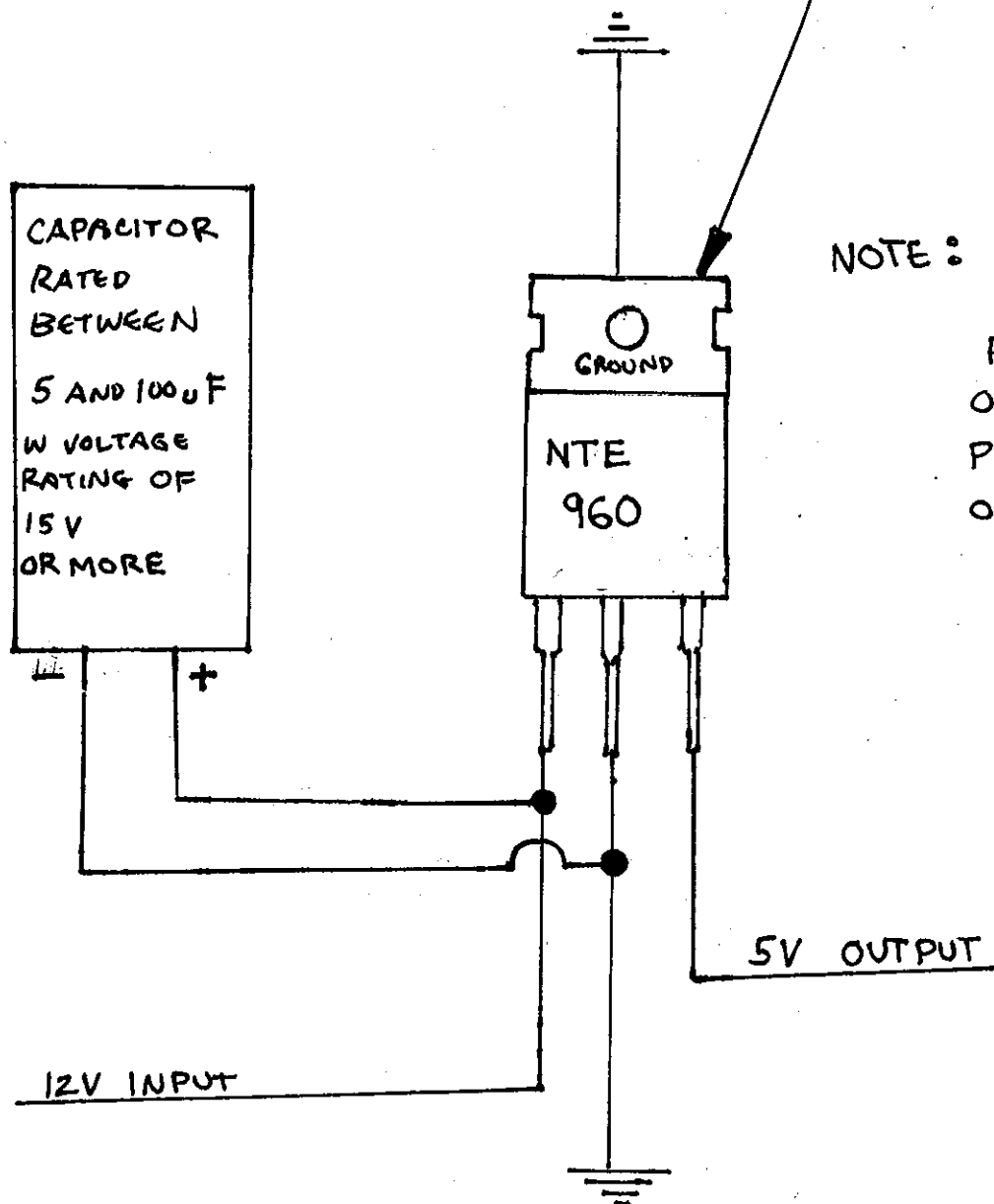


MOPAR  
SOLID STATE  
IVR

USE HEATSINK COMPOUND  
AND A FINNED HEATSINK  
UNDER CHIP TO DISSIPATE  
THE HEAT

CAPACITOR  
RATED  
BETWEEN  
5 AND 100  $\mu$ F  
W VOLTAGE  
RATING OF  
15V  
OR MORE



NOTE : CHIP PACKAGING  
SHOULD SHOW  
PINOUT LOCATION  
ON CHIP. USE  
PINOUT LOCATION  
ON PACKAGING